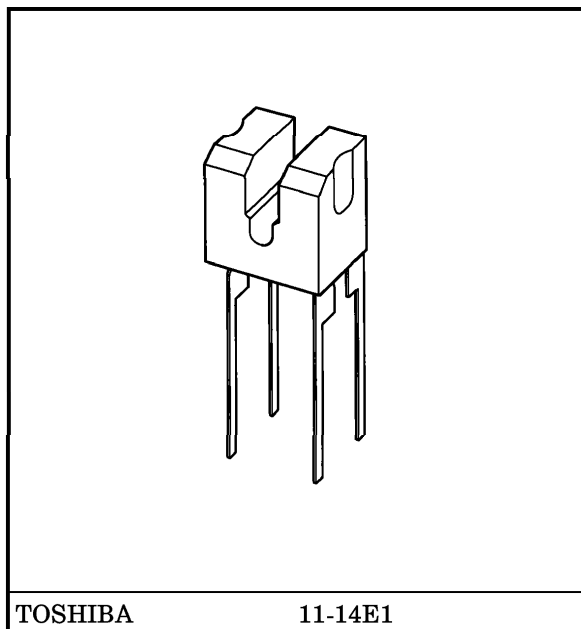


TOSHIBA PHOTO-INTERRUPTER INFRARED LED + PHOTOTRANSISTOR

TLP810MOTOR ROTATION AND IRIS DETECTION FOR
CAMERASTRACK DETECTION IN MICRO FLOPPY DISK
DRIVE

- Very small package
- High resolution : Slit width = 0.4 mm
- Gap : 1 mm
- Can be mounted directly on PCB using the stand off of lead.



TOSHIBA

11-14E1

Weight : 0.07 g (typ.)

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	RATING	UNIT
LED	Forward Current	I_F	50	mA
	Forward Current Derating (Ta > 25°C)	$I_F / ^\circ\text{C}$	-0.67	mA / °C
	Reverse Voltage	V_R	5	V
DETECTOR	Collector-Emitter Voltage	V_{CEO}	35	V
	Emitter Collector Voltage	V_{ECO}	5	V
	Collector Current	I_C	20	mA
	Collector Power Dissipation	P_C	75	mW
	Collector Power Dissipation (Ta > 25°C)	$\Delta P_C / ^\circ\text{C}$	-1	mW / °C
	Operating Temperature Range	T_{opr}	-25~85	°C
	Storage Temperature Range	T_{stg}	-40~100	°C

OPTICAL AND ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	Min	Typ.	Max	UNIT
LED	Forward Voltage	V _F	I _F = 10 mA	1.00	1.15	1.30	V
	Reverse Current	I _R	V _R = 5 V	—	—	10	μA
	Capacitance	C _T	V = 0, f = 1 MHz	—	30	—	pF
DETECTOR	Dark Current	I _D (ICEO)	V _{CE} = 20 V, I _F = 0	—	—	100	nA
	Capacitance	C _T	V = 0, f = 1 MHz	—	13	—	pF
COUPLED	Current Transfer Ratio	I _C / I _F	V _{CE} = 0.6 V, I _F = 5 mA	5	—	30	%
	Collector-Emitter Saturation Voltage	V _{CE (sat)}	I _F = 8 mA, I _C = 0.1 mA	—	0.1	0.4	V
	Rise Time	t _r	V _{CC} = 5 V, I _C = 0.2 mA, R _L = 1 kΩ	—	50	—	μs
	Fall Time	t _f		—	50	—	

PRECAUTIONS

The following points must be borne in mind.

- Soldering temperature : 260°C max
Soldering time : 5 s max
(Soldering must be performed 1.5 mm under the stopper.)
- Ensure that no residual flux or chemicals adhere to the light-emitting and light-receiving surfaces.

ENVIRONMENT

- The device should not be exposed to corrosive gases, such as hydrogen sulfide gas and a sea breeze.
- The device should not be exposed to dust.
- The device should not be exposed to direct sunlight.
In essence, the device should not be subjected to any load which may result in deformation or performance deterioration.

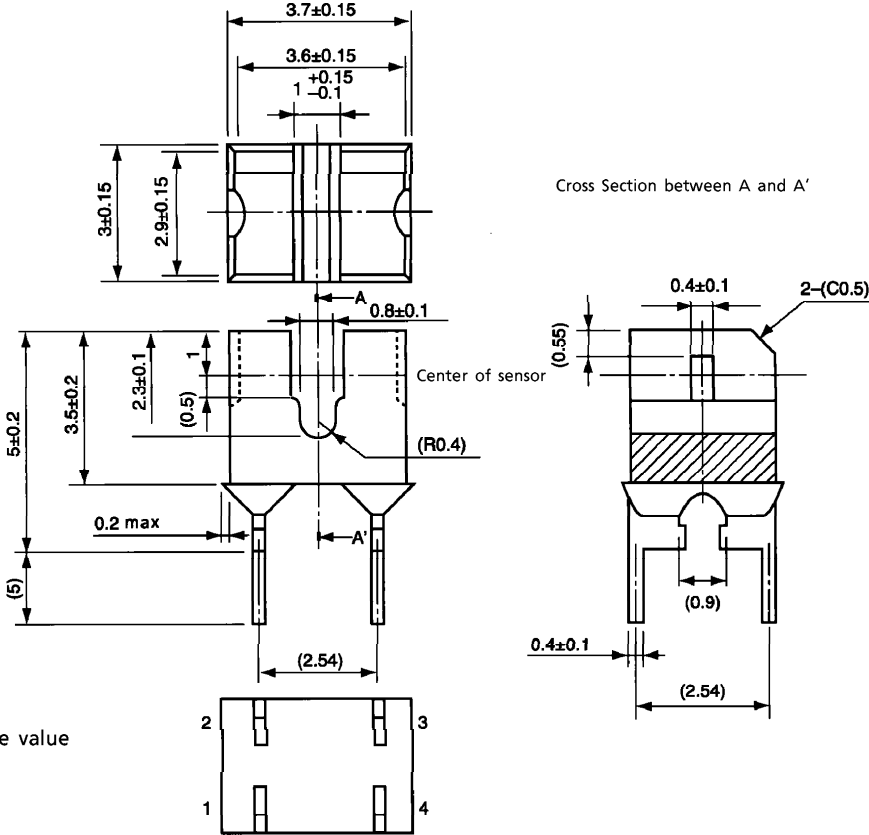
CIRCUIT DESIGN

- Conversion efficiency falls over time due to the current which flows in the infrared LED.
When designing a circuit, take into account this change in conversion efficiency over time.
The ratio of fluctuation in conversion efficiency to fluctuation in infrared LED optical output is 1 : 1.

$$\frac{I_C / I_F (t)}{I_C / I_F (0)} = \frac{P_O (t)}{P_O (0)}$$

PACKAGE DIMENSIONS
11-14E1

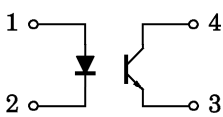
Unit : mm



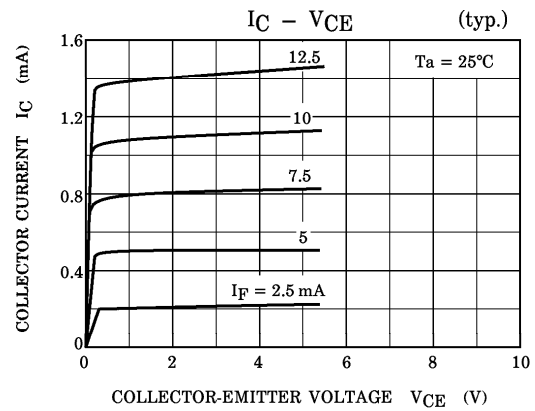
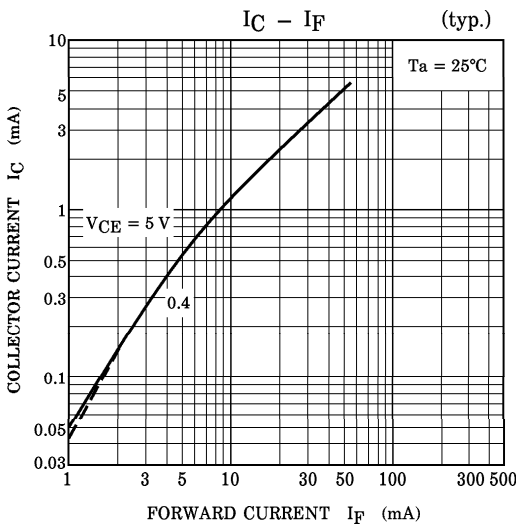
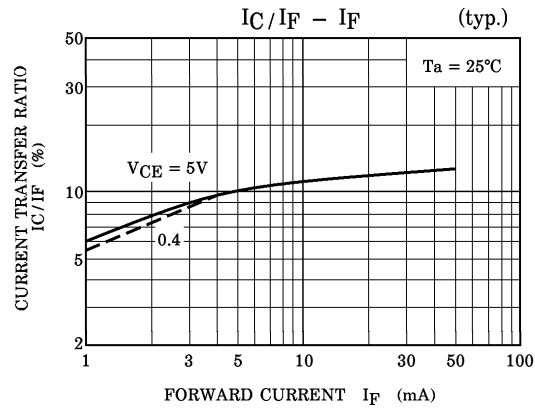
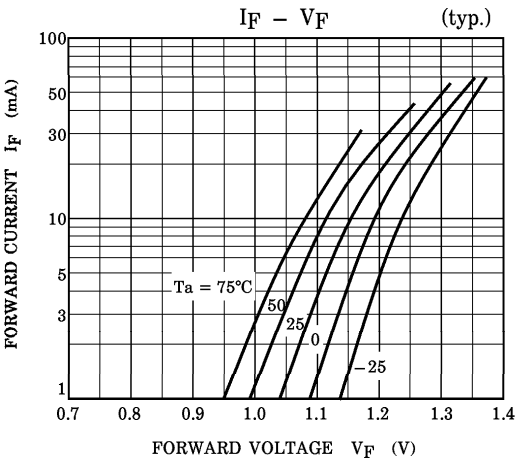
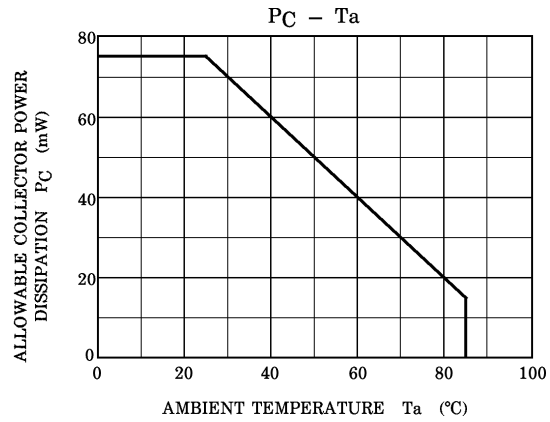
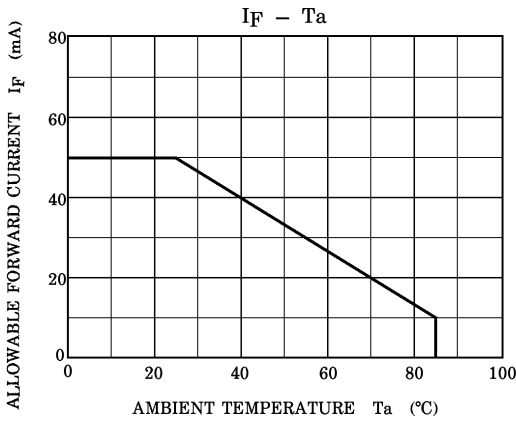
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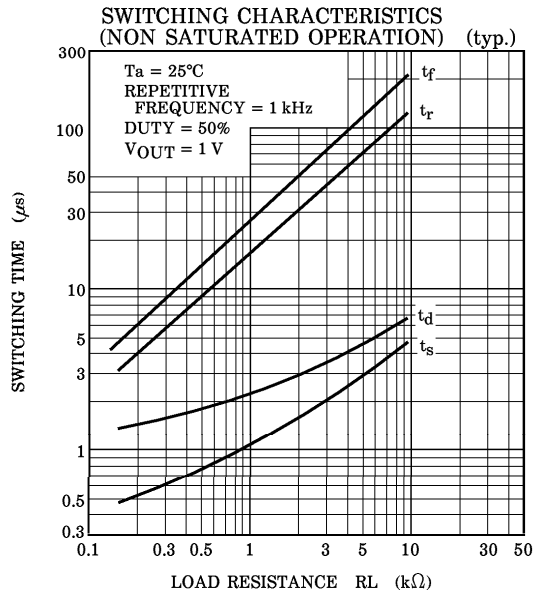
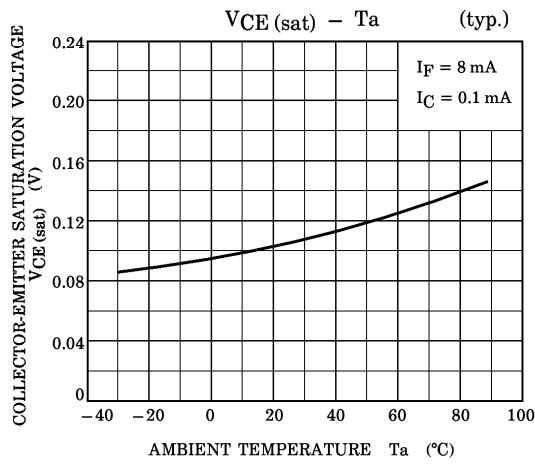
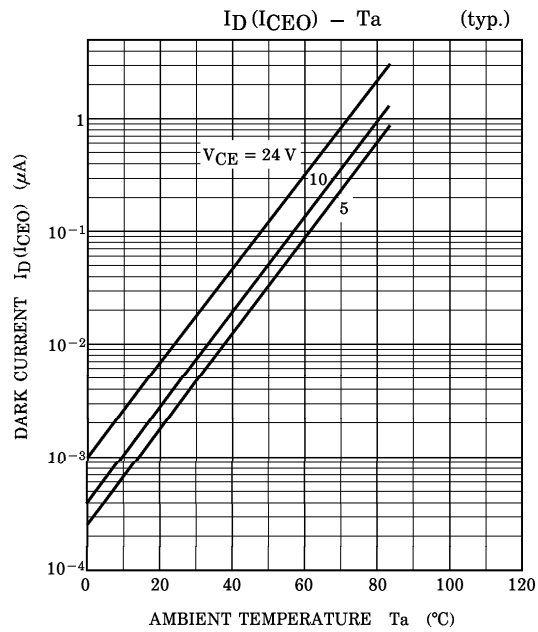
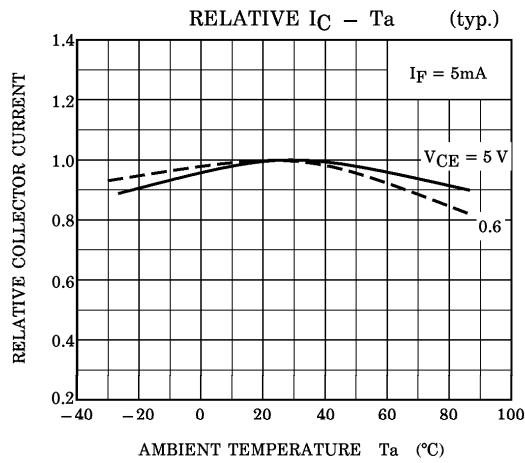
Weight : 0.07 g (typ.)

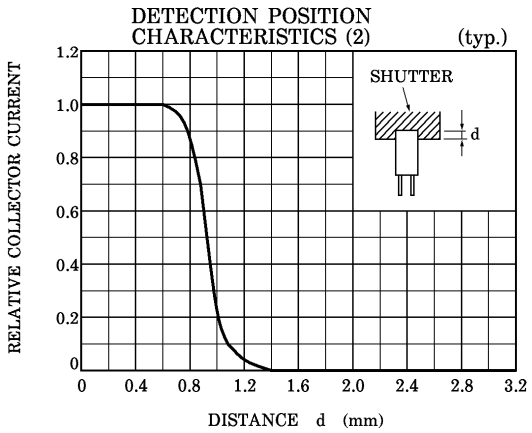
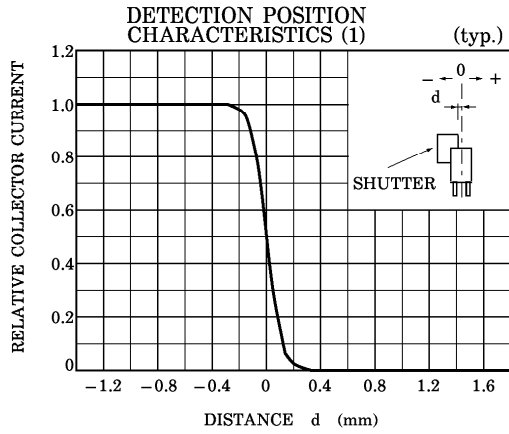
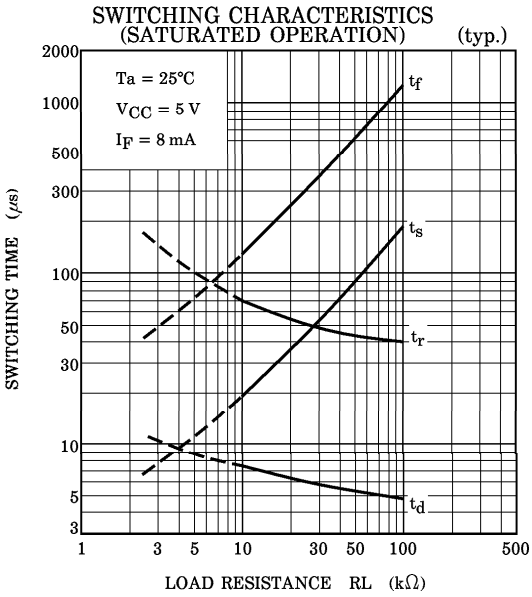
PIN CONNECTION



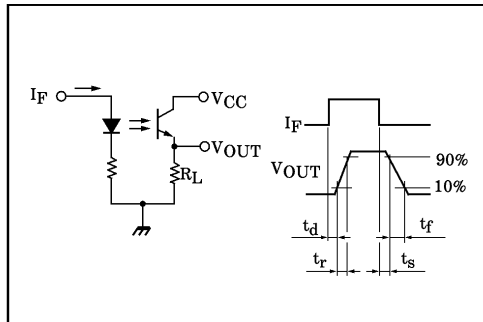
- 1. Anode
- 2. Cathode
- 3. Emitter
- 4. Collector







SWITCHING TIME TEST CIRCUIT



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